



● **DEVICE NUMBER : BL-H3JL32L-TRB**

佰鴻工業股份有限公司

www.brtled.com.

APPROVED	DRAWER
	

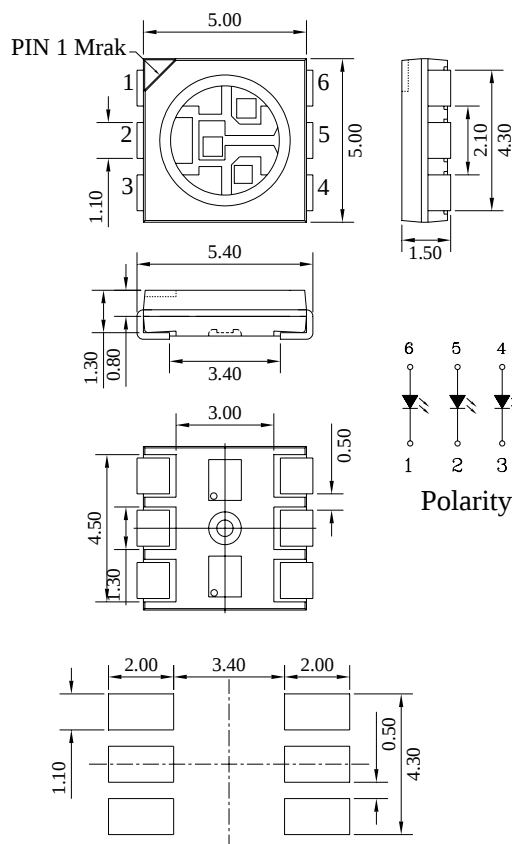
● Features:

1. Emitted Color: Super.Red
2. Lens Appearance: Water Clear.
3. 5.4x5.0x1.5mm standard package.
4. Suitable for all SMT assembly methods.
5. Compatible with infrared and vapor phase reflow solder process.
6. Compatible with automatic placement equipment.
7. This product doesn't contain restriction Substance, comply ROHS standard.

● Applications:

1. Automotive lighting.
2. Backlighting: LCDs, Key pads advertising.
3. Status indicators: Consumer & industrial electronics.
4. General use.

● Package Dimensions:



NOTES:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.10\text{mm}$ (0.004") unless otherwise specified.
3. Specifications are subject to change without notice.

Parameter	Symbol	Rating	Unit
Power Dissipation ^{*1}	P_D	225	mW
Forward Current ^{*2}	I_F	90	mA
Peak Forward Current ^{*3}	I_{FP}	100	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-40°C~100°C	-
Storage Temperature	T_{stg}	-40°C~100°C	-
Soldering Temperature	T_{sol}	See Page 6	-

^{*1} The values are based on 3-circuit performance

^{*2} Condition for I_{FP} is pulse of 1/10 duty and 3 msec width.

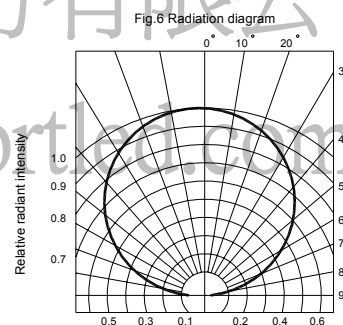
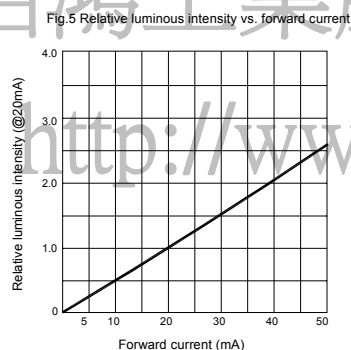
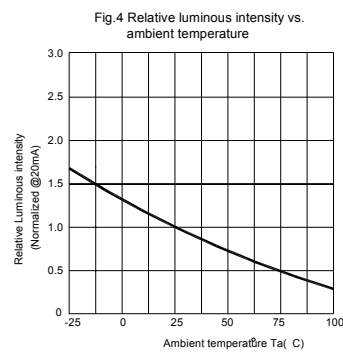
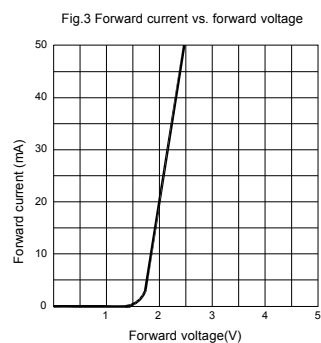
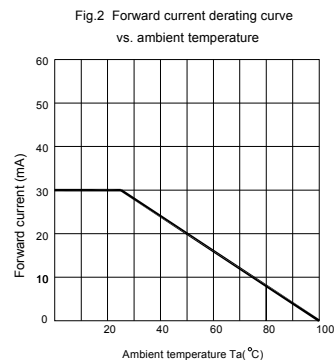
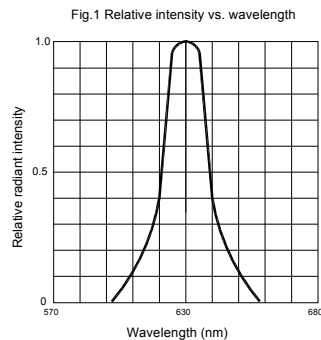
Electrical and optical characteristics(Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage ^{*1}	V _F	I _F =20mA	-	2.0	2.6	V
Luminous Intensity ^{*2}	I _v	I _F =60mA	-	1200	-	mcd
Peak Wavelength	λ _p	I _F =60mA	-	630	-	nm
Dominant Wavelength	λ _d	I _F =60mA	620	-	630	nm
Spectral LineHalf-width	Δλ	I _F =60mA	-	20	-	nm
Reverse Current	I _R	V _R =5V	-	-	10	μA
Viewing Angle	2θ _{1/2}	I _F =60mA	-	120	-	degree

*1 The values are based on 1-circuit performance

*2 The values are based on 3-circuit performance

Typical Electro-Optical Characteristics Curves.



ANODE

CATHODE

USER DIRECTION OF FEED

START

END

5.75±0.1

5.25±0.1

12.0±0.3

5.5±0.1

8.0±0.1

4.0±0.1

2.0±0.05

1.5±0.1

1.75±0.1

1.70±0.1

0.3

71.0±1

17.2±1.2

13.0±0.5

179±1

TRAILER

LEADER

FIXING TAPE

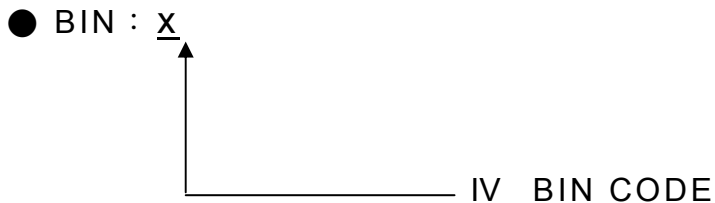
Technical drawing illustrating the packaging structure and dimensions:

- Top Left:** A circular component with a central pin and two side tabs. Below it, a downward arrow points to the **Aluminum Foil Bag**.
- Top Right:** A perspective view of an open **Aluminum Foil Bag** containing multiple stacked rectangular components. Dimensions: **12 bag/box**, **200** (height), **220** (width), and **185** (depth).
- Bottom Left:** A side view of the **Aluminum Foil Bag** showing a **Bar Code Label** and dimensions: **245** (height) and **220** (width).
- Bottom Right:** A perspective view of a **Carton** containing six boxes. Dimensions: **645** (height), **210** (width), and **470** (depth). The text **6 box/carton** is present.
- Watermark:** The text **佰鴻工業股份有限公司** and the URL **http://www.brtled.com** are overlaid on the drawing.

● Bin Limits

Intensity Bin Limits (At 60mA. The values are based on 3-circuit performance)

BIN CODE	Min. (mcd)	Max. (mcd)
V	715	1070
W	1070	1600
X	1600	2400



Notes:

1. I_v : Tolerance for each Bin limit is $\pm 15\%$
2. λ_d : Tolerance for each Bin limit is $\pm 1\text{nm}$
3. Bin categories are established for classification of products.
Products may not be available in all bin categories.

佰鴻工業股份有限公司

<http://www.brtled.com>

● Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	I _F =60mA Ta=Under room temperature Test time=1,000hrs	0/20
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+65°C±5°C RH=90%-95% Test time=240hrs	0/20
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-35°C±5°C Test time=1,000hrs	0/20
Environmental Test	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	-35°C ~ +25°C ~ +85°C ~ +25°C 60min 20min 60min 20min Test Time=5cycle	0/20
	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-35°C±5°C ~ +85°C±5°C 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating : 140°C-160°C, within 2 minutes. Operation heating : 260°C (Max.), within 10seconds. (Max.)	0/20

● Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V _F (V)	I _F =60mA	Over U ¹ x1.2
Reverse current	I _R (uA)	V _R =5V	Over U ¹ x2
Luminous intensity	I _v (mcd)	I _F =60mA	Below S ¹ X0.5

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. After each test, remove test pieces, wait for 2 hours and test pieces have returned to ambient temperature, then take next measurement.

● Soldering :

1. Manual Soldering

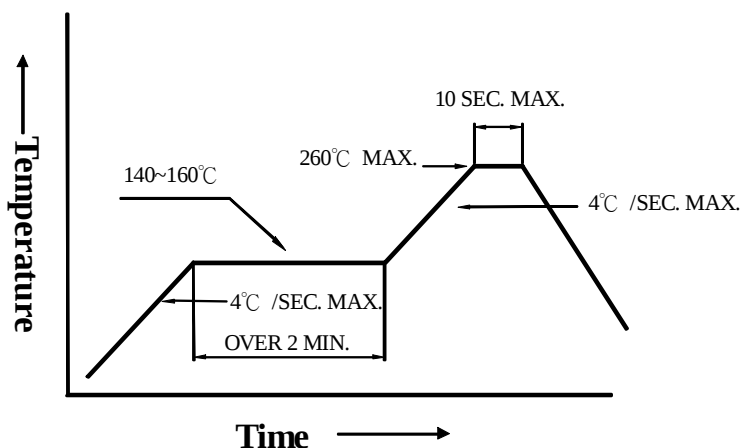
The temperature of the iron tip should not be higher than 350°C and Soldering time to be within 3 seconds per solder-pad.

2. Reflow Soldering

Preheating : 140°C~160°C ±5°C ,within 2 minutes.

Operation heating : 260°C (Max.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).

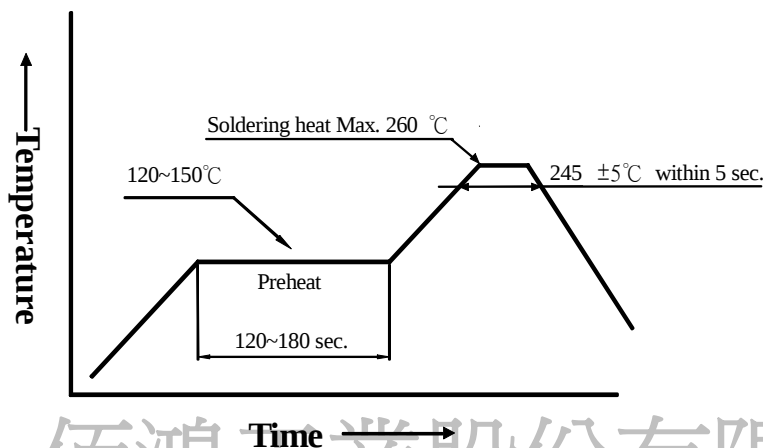


3. DIP soldering (Wave Soldering) :

Preheating : 120°C~150°C ,within 120~180 sec.

Operation heating : 245°C±5°C within 5 sec. 260°C (Max)

Gradual Cooling (Avoid quenching).



● Handling :

Care must be taken not to damage LED's epoxy resin while exposing to high temperature or contact LED's epoxy resin with hard or sharp objects, such as metal hook, tweezer or sand blasting.

<http://www.brtled.com>

● Notes for designing:

Current limiting resistor must be used in the circuit to drive BRIGHT LEDs within the rated figures and not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF cycles. When using pulse driving, the average current must be within the rated figures. And the circuit should be designed to avoid reverse voltage when turning off the BRIGHT LEDs.

● Storage:

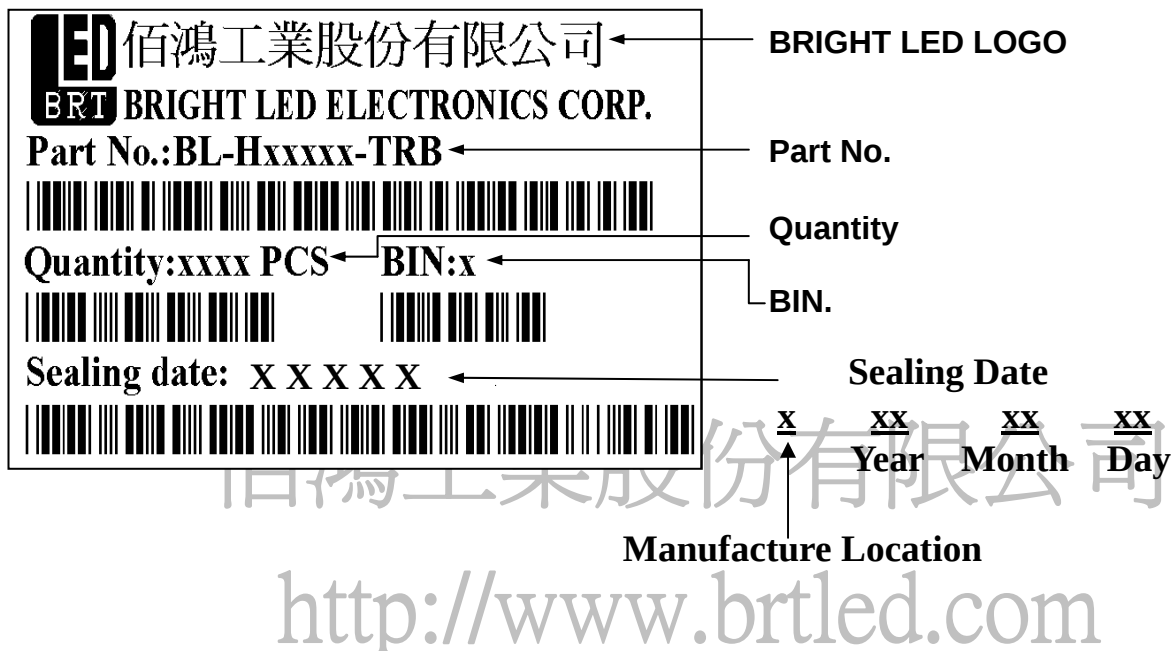
In order to avoid the absorption of moisture, it is recommended to solder BRIGHT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5°C -30°C (41°F) Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
 - a. Completed within 168 hours.
 - b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
 - (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions:
 - 48 hours at 60°C±3°C.

● Package and Label of Products:

- (1) Package: Products are packed in one bag of 2000 pcs (one taping reel) and a label is attached to each bag.
- (2) Label:



The diagram shows a rectangular label with the following fields and arrows:

- BRIGHT LED LOGO**: Points to the logo on the top left.
- Part No.**: Points to the text "Part No.:BL-Hxxxxx-TRB".
- Quantity**: Points to the text "Quantity:xxxx PCS".
- BIN.**: Points to the text "BIN:x".
- Sealing Date**: Points to the text "Sealing date: X X X X X".
- Manufacture Location**: Points to the text "X XX XX XX" which is further divided into "Year", "Month", and "Day".

The label also contains the company name "佰鴻工業股份有限公司" and "BRT BRIGHT LED ELECTRONICS CORP." at the top, and a large barcode at the bottom.